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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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v04.1211

GaAs MMIC FUNDAMENTAL MIXER MODULE, 11 - 20 GHz

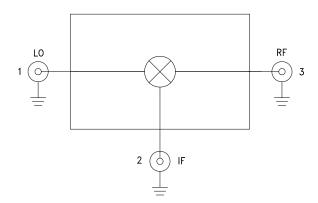


Typical Applications

The HMC-C051 is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

Functional Diagram



Features

High LO/RF Isolation: 43 dB

Passive Double Balanced Topology

Low Conversion Loss: 7 dB

Wide IF Bandwidth: DC - 6 GHz

Robust 1,000V ESD, Class 1C

Hermetically Sealed Module

Field Replaceable 2.92 mm (RF and LO) and

SMA (IF) Connectors

-55 to +85 °C Operating Temperature

General Description

The HMC-C051 is a general purpose double balanced mixer housed in a miniature hermetic module that can be used as an upconverter or downconverter between 11 and 20 GHz. This mixer is fabricated in a GaAs MESFET process, and requires no external components or matching circuitry. The HMC-C051 provides excellent LO to RF and LO to IF isolation due to optimized balun structures. The module features removable 2.92 mm (RF and LO) and SMA (IF) connectors which can be detached to allow direct connection of the I/O pins to a microstrip or coplanar circuit.

Electrical Specifications, $T_A = +25^{\circ}$ C, IF= 100 MHz, LO= +13 dBm*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF & LO		12 - 16			11 - 20		GHz
Frequency Range, IF		DC - 6			DC - 6		GHz
Conversion Loss		7	9		8	11	dB
Noise Figure (SSB)		6			7.5		dB
LO to RF Isolation	38	44		32	43		dB
LO to IF Isolation	36	40		36	41		dB
RF to IF Isolation	19	28		19	29		dB
IP3 (Input)		17			18		dBm
IP2 (Input)		44			41		dBm
1 dB Gain Compression (Input)		10			11		dBm

^{*}Unless otherwise noted, all measurements performed as downconverter, IF= 100 MHz.

HMC-C051* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS 🖵

View a parametric search of comparable parts.

DOCUMENTATION

Data Sheet

• HMC-C051 Data Sheet

TOOLS AND SIMULATIONS 🖳

• HMC-C051 S-Parameter

DESIGN RESOURCES 🖳

- HMC-C051 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC-C051 EngineerZone Discussions.

SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

TECHNICAL SUPPORT 🖳

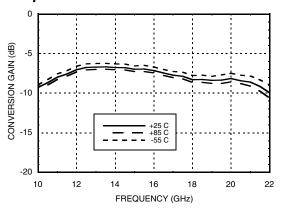
Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK 🖳

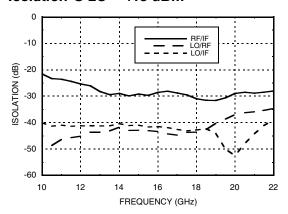
Submit feedback for this data sheet.



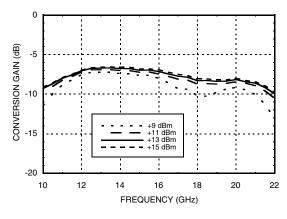
Conversion Gain vs. Temperature @ LO = +13 dBm



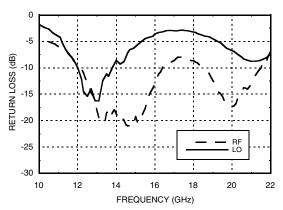
Isolation @ LO = +13 dBm



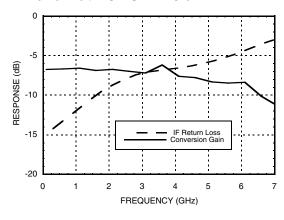
Conversion Gain vs. LO Drive



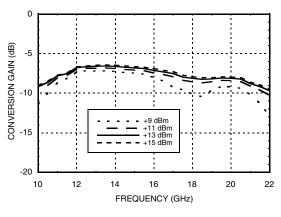
Return Loss @ LO = +13 dBm



IF Bandwidth @ LO = +13 dBm

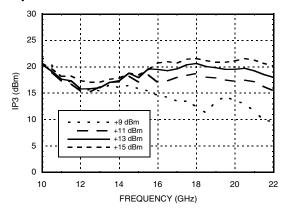


Upconverter Performance Conversion Gain vs. LO Drive

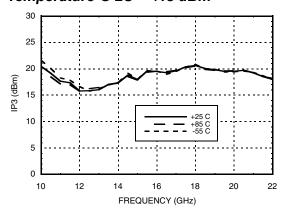




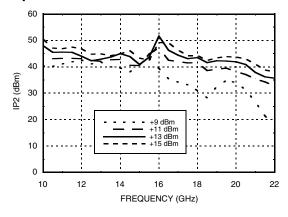
Input IP3 vs. LO Drive *



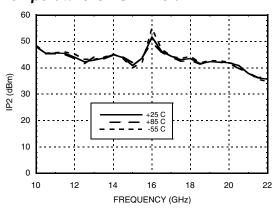
Input IP3 vs. Temperature @ LO = +13 dBm*



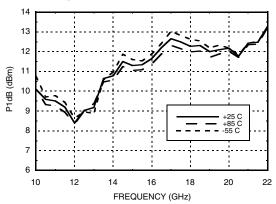
Input IP2 vs. LO Drive *



Input IP2 vs. Temperature @ LO = +13 dBm*



Input P1dB vs. Temperature @ LO = +13 dBm



^{*} Two-tone input power = -10 dBm each tone, 1 MHz spacing.



Absolute Maximum Ratings

RF / IF Input	+25 dBm
LO Drive	+25 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1C



MxN Spurious Outputs

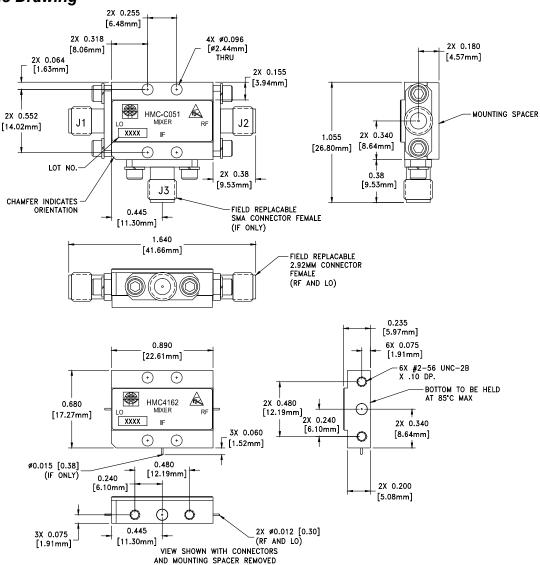
	nLO					
mRF	0	1	2	3	4	
0	xx	15	34	32	xx	
1	26	0	43	47	61	
2	77	74	60	72	99	
3	95	94	98	72	92	
4	xx	108	108	103	106	

RF Frequency= 15 GHz @ -10 dBm LO Frequency= 14.9 GHz @ +13 dBm

All values in dBc below IF power level (1RF - 1LO).



Outline Drawing



Package Information

•	
Package Type	C-11
Package Weight [1]	20 gms (Typ.)
Spacer Weight	2.6 gms (Typ.)

[1] Package weight includes the connectors

[2] ±1 gms Tolerance

NOTES:

- 1. PACKAGE, LEADS, COVER MATERIAL: KOVAR™
- 2. PLATING: GOLD PLATE OVER NICKEL PLATE.
- 3. MOUNTING SPACER: NICKEL PLATED ALUMINUM. 4. ALL DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. TOLERANCES: ±0.010 [0.23] UNLESS OTHERWISE SPECIFIED
- 6. FIELD REPLACEABLE 2.92mm CONNECTORS. TENSOLITE 231CCSF OR EQUIVALENT.



Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	LO	This pin is DC coupled and matched to 50 Ohms.	TO 0
2	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source or sink more than 2 mA of current or part non-function and possible part failure will result.	IFO
3	RF	This pin is DC coupled and matched to 50 Ohms.	RF O